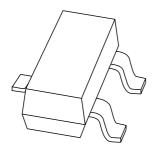
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4320T 20 V NPN low V_{CEsat} transistor

Product specification Supersedes data of 2002 Aug 08 2004 Mar 18





Philips Semiconductors

20 V NPN low V_{CEsat} transistor

PBSS4320T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat} and corresponding low R_{CEsat}
- · High collector current capability
- High collector current gain
- Improved efficiency due to reduced heat generation.

APPLICATIONS

- · Power management applications
- Low and medium power DC/DC convertors
- · Supply line switching
- · Battery chargers
- Linear voltage regulation with low voltage drop-out (LDO).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT23 plastic package. PNP complement: PBSS5320T.

MARKING

| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| PBSS4320T | ZG* |

Note

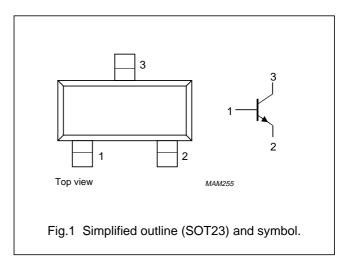
- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | UNIT |
|--------------------|-----------------------------------|------|------|
| V _{CEO} | collector-emitter voltage | 20 | V |
| I _C | collector current (DC) | 2 | Α |
| I _{CRP} | repetitive peak collector current | 3 | А |
| R _{CEsat} | equivalent on-resistance | 105 | mΩ |

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|--|
| 1 | base | |
| 2 | emitter | |
| 3 | collector | |



ORDERING INFORMATION

| TYPE | PACKAGE | | | | |
|-----------|---------|--|-------|--|--|
| NUMBER | NAME | NAME DESCRIPTION VERSION | | | |
| PBSS4320T | _ | plastic surface mounted package; 3 leads | SOT23 | | |

20 V NPN low V_{CEsat} transistor

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-----------------------------------|---|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 20 | V |
| V _{CEO} | collector-emitter voltage | open base | _ | 20 | V |
| V _{EBO} | emitter-base voltage | open collector | _ | 5 | ٧ |
| Ic | collector current (DC) | | _ | 2 | А |
| I _{CRP} | repetitive peak collector current | note 1 | _ | 3 | А |
| I _{CM} | peak collector current | single peak | _ | 5 | А |
| I _B | base current (DC) | | _ | 0.5 | А |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 2 | _ | 300 | mW |
| | | T _{amb} ≤ 25 °C; note 3 | _ | 480 | mW |
| | | T _{amb} ≤ 25 °C; note 4 | _ | 540 | mW |
| | | T _{amb} ≤ 25 °C; notes 1 and 2 | _ | 1.2 | W |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | _ | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Notes

- 1. Operated under pulsed conditions: pulse width $t_p \le 100$ ms; duty cycle $\delta \le 0.25$.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|-------------------------------------|----------------------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to | in free air; note 1 | 417 | K/W |
| | ambient | in free air; note 2 | 260 | K/W |
| | | in free air; note 3 | 230 | K/W |
| | | in free air; notes 1 and 4 | 104 | K/W |

Notes

- Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².
- 4. Operated under pulsed conditions: pulse width $t_p \le 100$ ms; duty cycle $\delta \le 0.25$.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

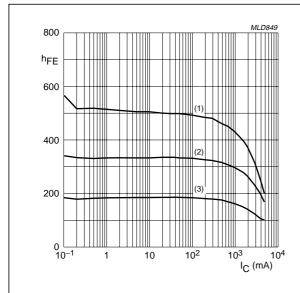
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------|---|------|------|------|------|
| I _{CBO} | collector-base cut-off current | I _E = 0 A; V _{CB} = 20 V | _ | _ | 100 | nA |
| | | I _E = 0 A; V _{CB} = 20 V; T _j = 150 °C | _ | _ | 50 | μΑ |
| I _{EBO} | emitter-base cut-off current | I _C = 0 A; V _{EB} = 5 V | _ | _ | 100 | nA |
| h _{FE} | DC current gain | I _C = 100 mA; V _{CE} = 2 V | 220 | _ | _ | |
| | | I _C = 500 mA; V _{CE} = 2 V | 220 | _ | _ | |
| | | I _C = 1 A; V _{CE} = 2 V; note 1 | 220 | _ | _ | |
| | | I _C = 2 A; V _{CE} = 2 V; note 1 | 200 | _ | _ | |
| | | I _C = 3 A; V _{CE} = 2 V; note 1 | 150 | _ | _ | |
| V _{CEsat} | collector-emitter saturation | I _C = 500 mA; I _B = 50 mA | _ | _ | 70 | mV |
| voltage | /oltage | I _C = 1 A; I _B = 50 mA | _ | _ | 120 | mV |
| | | I _C = 2 A; I _B = 40 mA; note 1 | _ | _ | 230 | mV |
| | | I _C = 2 A; I _B = 200 mA; note 1 | _ | _ | 210 | mV |
| | | I _C = 3 A; I _B = 300 mA; note 1 | _ | _ | 310 | mV |
| R _{CEsat} | equivalent on-resistance | I _C = 2 A; I _B = 200 mA; note 1 | _ | 80 | 105 | mΩ |
| V _{BEsat} | base-emitter saturation | I _C = 2 A; I _B = 40 mA; note 1 | _ | _ | 1.1 | V |
| voltage | | I _C = 3 A; I _B = 300 mA; note 1 | _ | _ | 1.2 | V |
| V _{BEon} | base-emitter turn-on voltage | I _C = 1 A; V _{CE} = 2 V; note 1 | 1.2 | _ | _ | V |
| f _T | transition frequency | I _C = 100 mA; V _{CE} = 5 V; f = 100 MHz | 100 | _ | _ | MHz |
| C _c | collector capacitance | $I_E = I_e = 0 \text{ A}; V_{CB} = 10 \text{ V}; f = 1 \text{ MHz}$ | _ | _ | 35 | pF |

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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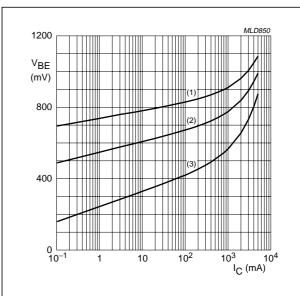
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 $V_{CE} = 2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

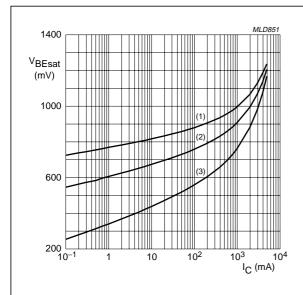
Fig.2 DC current gain as a function of collector current; typical values.



V_{CE} = 2 V.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

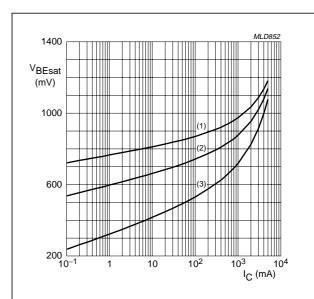
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.4 Base-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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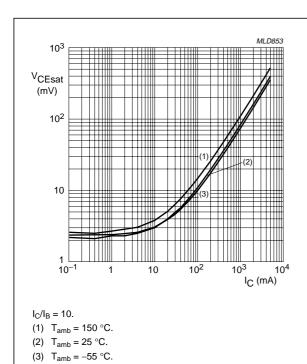
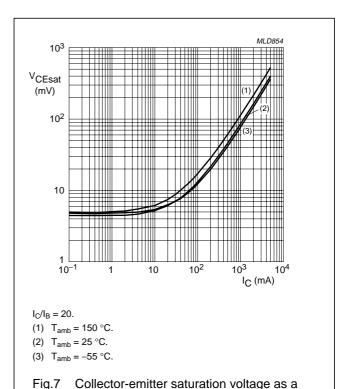
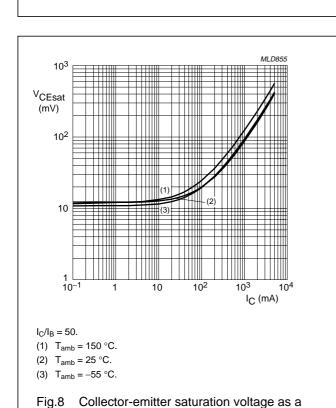
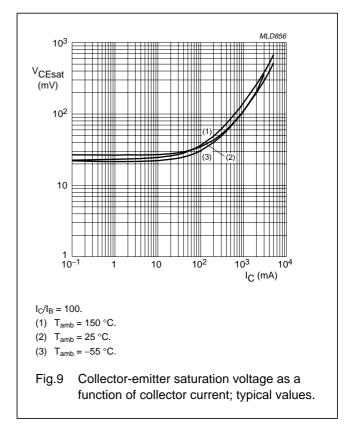


Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



function of collector current; typical values.



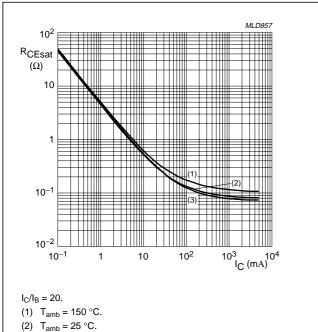


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function of collector current; typical values.

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- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.10 Equivalent on-resistance as a function of collector current; typical values.

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PACKAGE OUTLINE

mm

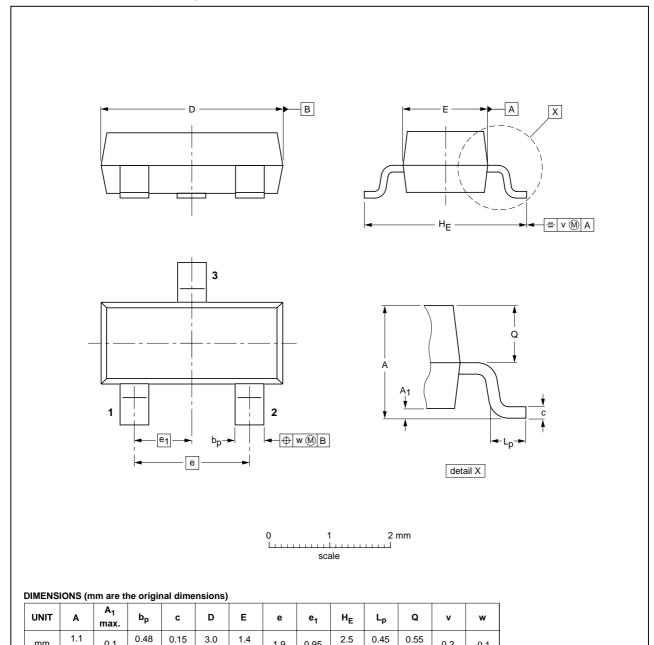
0.1

0.38

0.9

Plastic surface mounted package; 3 leads

SOT23



| OUTLINE | REFERENCES | | | EUROPEAN | ISSUE DATE | |
|---------|------------|----------|--|----------|------------|---------------------------------|
| VERSION | IEC | JEDEC | | | ISSUE DATE | |
| SOT23 | | TO-236AB | | | | 97-02-28 99-09-13 |

0.2

0.1

0.95

1.9

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DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS(2)(3) | DEFINITION |
|-------|-------------------------------------|-------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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